

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC7MH574FK**

## **Octal D-Type Flip-Flop with 3-State Output**

The TC7MH574FK is an advanced high speed CMOS octal flip-flop with 3-state output fabricated with silicon gate C<sup>2</sup>MOS technology.

It achieves the high speed operation similar to equivalent bipolar schottky TTL while maintaining the CMOS low power dissipation.

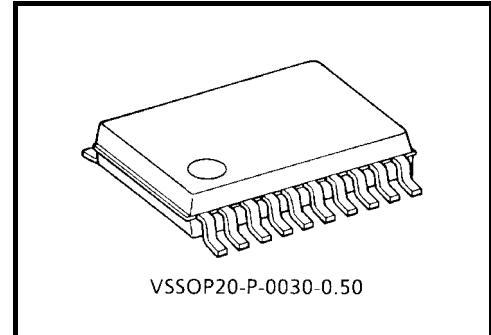
This 8 bit D-type flip-flop is controlled by a clock input (CK) and an output enable input ( $\overline{OE}$ ).

When the  $\overline{OE}$  input is high, the eight outputs are in a high impedance state.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

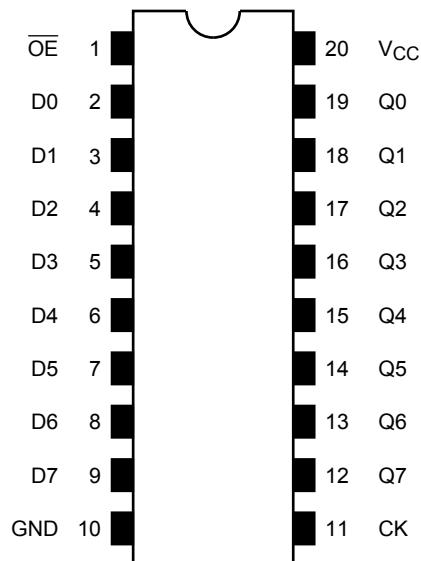
## **Features**

- High speed:  $f_{max} = 180$  MHz (typ.) ( $V_{CC} = 5$  V)
- Low power dissipation:  $I_{CC} = 4 \mu A$  (max) ( $T_a = 25^\circ C$ )
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\%$   $V_{CC}$  (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays:  $t_{PLH} \approx t_{PHL}$
- Wide operating voltage range:  $V_{CC} (\text{opr}) = 2\sim 5.5$  V
- Low noise:  $V_{OLP} = 1.0$  V (max)
- Pin and function compatible with 74ALS574

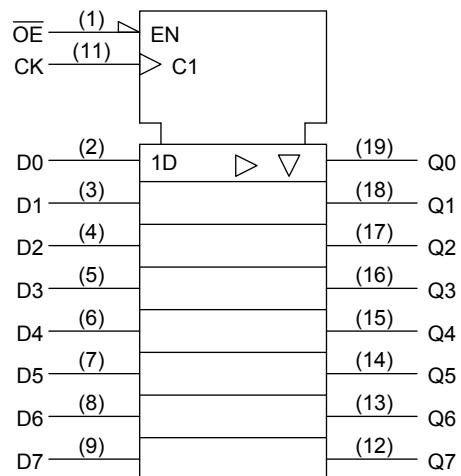


Weight: 0.03 g (typ.)

## Pin Assignment (top view)



## IEC Logic Symbol



## Truth Table

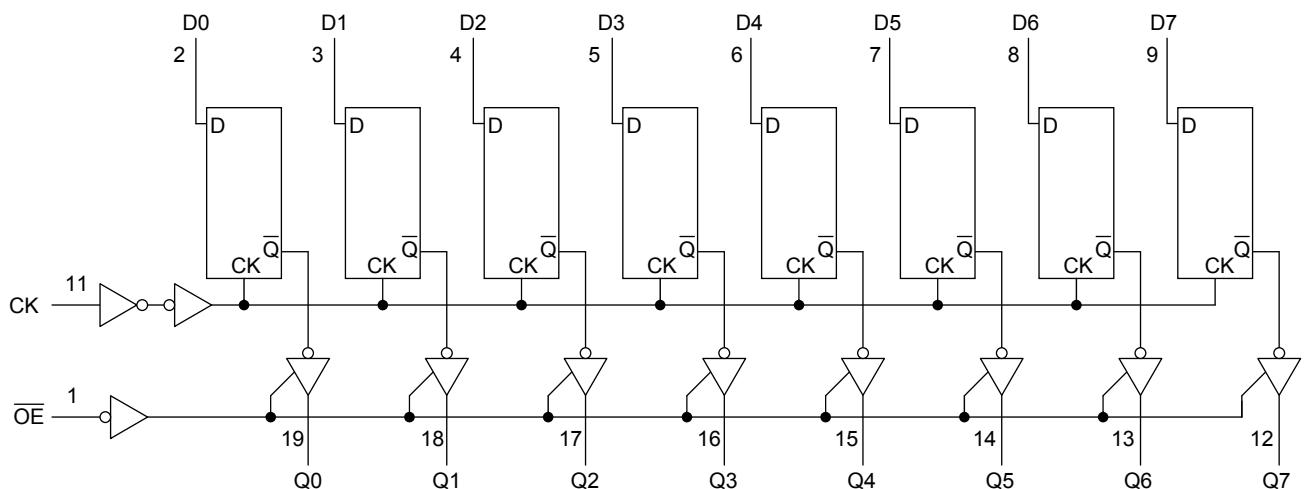
Inputs			Outputs
$\overline{OE}$	CK	D	
H	X	X	Z
L	↓	X	$Q_n$
L	↑	L	L
L	↑	H	H

X: Don't care

Z: High impedance

 $Q_n$ : No change

## System Diagram



**Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5~7.0	V
DC input voltage	V <sub>IN</sub>	-0.5~7.0	V
DC output voltage	V <sub>OUT</sub>	-0.5~V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	-20	mA
Output diode current	I <sub>OK</sub>	±20	mA
DC output current	I <sub>OUT</sub>	±25	mA
DC V <sub>CC</sub> /ground current	I <sub>CC</sub>	±75	mA
Power dissipation	P <sub>D</sub>	180	mW
Storage temperature	T <sub>stg</sub>	-65~150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

**Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2.0~5.5	V
Input voltage	V <sub>IN</sub>	0~5.5	V
Output voltage	V <sub>OUT</sub>	0~V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	-40~85	°C
Input rise and fall time	dt/dv	0~100 (V <sub>CC</sub> = 3.3 ± 0.3 V) 0~20 (V <sub>CC</sub> = 5 ± 0.5 V)	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

**Electrical Characteristics****DC Characteristics**

Characteristics		Symbol	Test Condition	V <sub>CC</sub> (V)	Ta = 25°C			Ta = -40~85°C		Unit	
					Min	Typ.	Max	Min	Max		
Input voltage	High level	V <sub>IH</sub>	—	2.0	1.50	—	—	1.50	—	V	
				3.0~5.5	V <sub>CC</sub> × 0.7	—	—	V <sub>CC</sub> × 0.7	—		
	Low level	V <sub>IL</sub>	—	2.0	—	—	0.50	—	0.50		
				3.0~5.5	—	—	V <sub>CC</sub> × 0.3	—	V <sub>CC</sub> × 0.3		
Output voltage	High level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	2.0	1.9	2.0	—	1.9	V	
					3.0	2.9	3.0	—	2.9		
					4.5	4.4	4.5	—	4.4		
				I <sub>OH</sub> = -4 mA	3.0	2.58	—	—	2.48		
				I <sub>OH</sub> = -8 mA	4.5	3.94	—	—	3.80		
	Low level	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA	2.0	—	0	0.1	—	V	
					3.0	—	0	0.1	—		
					4.5	—	0	0.1	—		
				I <sub>OL</sub> = 4 mA	3.0	—	—	0.36	—		
				I <sub>OL</sub> = 8 mA	4.5	—	—	0.36	—		
3-state output off-state current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND		5.5	—	—	±0.25	—	±2.50	μA	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0~5.5	—	—	±0.1	—	±1.0	μA	
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	—	—	4.0	—	40.0	μA	

**Timing Requirements (Input: t<sub>r</sub> = t<sub>f</sub> = 3 ns)**

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Ta = 25°C		Ta = -40~85°C		Unit
				Typ.	Limit	Limit	Limit	
Minimum pulse width (CK)	t <sub>w</sub> (H) t <sub>w</sub> (L)	—	3.3 ± 0.3	—	5.0	5.0	5.0	ns
			5.0 ± 0.5	—	5.0	5.0	5.0	
Minimum set-up time	t <sub>s</sub>	—	3.3 ± 0.3	—	3.5	3.5	3.5	ns
			5.0 ± 0.5	—	3.5	3.5	3.5	
Minimum hold time	t <sub>h</sub>	—	3.3 ± 0.3	—	1.5	1.5	1.5	ns
			5.0 ± 0.5	—	1.5	1.5	1.5	

AC Characteristics (Input:  $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Ta = 25°C			Ta = -40~85°C		Unit	
			V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Typ.	Max		
Propagation delay time (CK-Q)	$t_{pLH}$ $t_{pHL}$	—	3.3 ± 0.3	15	—	8.5	13.2	1.0	15.5
				50	—	11.0	16.7	1.0	19.0
			5.0 ± 0.5	15	—	5.6	8.6	1.0	10.0
				50	—	7.1	10.6	1.0	12.0
3-state output enable time	$t_{pZL}$ $t_{pZH}$	$R_L = 1 \text{ k}\Omega$	3.3 ± 0.3	15	—	8.2	12.8	1.0	15.0
				50	—	10.7	16.3	1.0	18.5
			5.0 ± 0.5	15	—	5.9	9.0	1.0	10.5
				50	—	7.4	11.0	1.0	12.5
3-state output disable time	$t_{pLZ}$ $t_{pHZ}$	$R_L = 1 \text{ k}\Omega$	3.3 ± 0.3	50	—	11.0	15.0	1.0	17.0
			5.0 ± 0.5	50	—	7.1	10.1	1.0	11.5
Maximum clock frequency	$f_{max}$	—	3.3 ± 0.3	15	80	125	—	65	—
				50	50	75	—	45	—
			5.0 ± 0.5	15	130	180	—	110	—
				50	85	115	—	75	—
Output to output skew	$t_{osLH}$ $t_{osHL}$	(Note 1)	3.3 ± 0.3	50	—	—	1.5	—	1.5
			5.0 ± 0.5	50	—	—	1.0	—	1.0
Input capacitance	C <sub>IN</sub>	—	—	—	4	10	—	10	pF
Output capacitance	C <sub>OUT</sub>	—	—	—	6	—	—	—	pF
Power dissipation capacitance	C <sub>PD</sub>	(Note 2)		—	28	—	—	—	pF

Note 1: This parameter is guaranteed by design.

$$t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|$$

Note 2: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

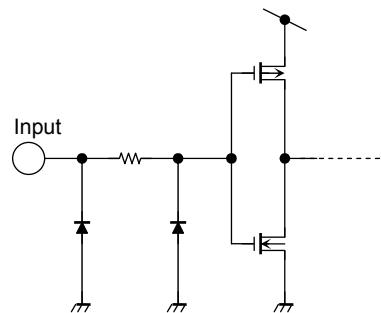
$$I_{CC}(\text{opr}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per F/F)}$$

And the total CPD when n pcs of latch operate can be gained by the following equation:

$$C_{PD}(\text{total}) = 20 + 8 \cdot n$$

**Noise Characteristics (Input:  $t_r = t_f = 3 \text{ ns}$ )**

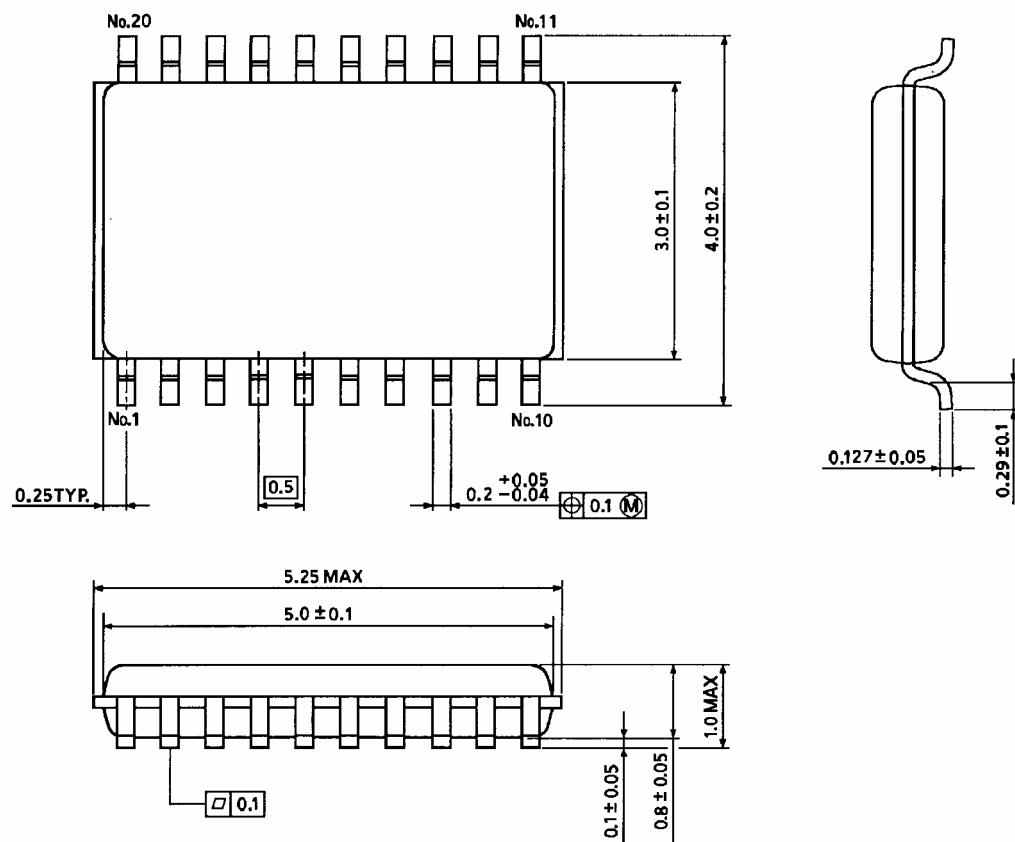
Characteristics	Symbol	Test Condition	Ta = 25°C			Unit
			V <sub>CC</sub> (V)	Typ.	Limit	
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>O LP</sub>	C <sub>L</sub> = 50 pF	5.0	0.8	1.0	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>O LV</sub>	C <sub>L</sub> = 50 pF	5.0	-0.8	-1.0	V
Minimum high level dynamic input voltage V <sub>IHD</sub>	V <sub>I HD</sub>	C <sub>L</sub> = 50 pF	5.0	—	3.5	V
Maximum low level dynamic input voltage V <sub>ILD</sub>	V <sub>I LD</sub>	C <sub>L</sub> = 50 pF	5.0	—	1.5	V

**Input Equivalent Circuit**

**Package Dimensions**

VSSOP20-P-0030-0.50

Unit : mm



Weight: 0.03 g (typ.)

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20070701-EN GENERAL

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